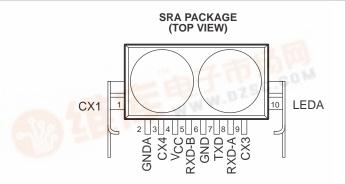
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<u>捷多邦,专业PCB打样工厂,24小时加急出货</u> TSLM1100 IrDA COMPLIANT TRANSCEIVER

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- Fully Compliant with IrDA 1.1 (4 MBPS)
- Compatible with ASK, HP-SIR and TV Remote
- No Programming Required to Switch Speeds
- Backward Compatible to Slower IrDA Speeds
- Excellent Noise Immunity
- Fully Supportable by all Interface Chips
- Designed to Compensate for Light Loss Caused by Cosmetic Windows



description

The TSLM1100 is an infrared transceiver that provides the interface between logic and IR signals for through-air, serial, half-duplex IR data links. The TSLM1100 is compliant with the Infrared Data Association (IrDA) 1.1 physical-layer specification. Additionally, the TSLM1100 is compatible with ASK, HP-SIR and TV Remote standards.

The TSLM1100 is a hybrid device that includes a high-speed AIGaAs 870-nm LED, a silicon intrinsic PN junction (PIN) diode, and a LinCMOS transceiver integrated circuit. This IC has the LED driver and a receiver that provides two output signals: RXD-A for data rates from 2.4 kb/s to 115.2 kb/s and RXD-B for data rates of 576 kb/s to 4.0 Mb/s.

The device is encapsulated in a visible-light-rejecting plastic package that has integral lenses for the LED and the PIN diode. The receiver lens increases the effective area of the PIN diode to increase sensitivity. The LED lens is designed to provide a beam angle of $\pm 30^{\circ}$. The receiver outputs pulse low when an IR signal is detected. The power supply for both PIN diode and LED should be filtered to minimize noise from external sources.

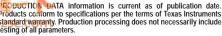
This transceiver is well suited for a wide variety of IR interface applications including: PC notebooks, PDAs, pagers, printers, cameras, LANs, telephones and industrial handheld devices.

FUNCTION TABLE INPUTS OUTPUTS Ee **RXD-A** RXD-B TXD le(LED) Х NV NV ٧н High VIL EI(IH)[†] Low Low NV VIL Low NV $E_{I(IH)}$ Low High High VIL EI(IL) I ow

X – don't care, NV – not valid † Data rates up to 115.2 kb/s ‡ Data rates > 115.2 kb/s

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TSLM1100 Irda compliant transceiver

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PIN		DESCRIPTION				
NAME	NO.	DESCRIPTION				
CX1	1	Photodiode bypass capacitor				
GNDA	2	Analog ground				
CX4	3	Averaging capacitor				
VCC	4	Supply voltage				
RXD-B	5	Receiver data output – Channel B				
GND	6	Ground				
TXD	7	Transmitter data input				
RXD-A	8	Receiver data output – Channel A				
CX3	9	Threshold capacitor				
LEDA	10	LED anode				

Terminal Functions

absolute maximum ratings over operating free-air temperature (unless otherwise noted)[†]

Supply voltage, V _{CC}	
LED anode voltage range, V _{I(LEDA)}	–0.5 V to 7 V
Receiver data output voltage range: V _{O(RXD-A)}	-0.5 V to V _{CC} + 0.5 V
V _{O(RXD-B)} · · · · · · · · · · · · · · · · · · ·	-0.5 V to V _{CC} + 0.5 V
Average LED current, I _{I(LED)(avg)} : Direct current	100 mA
Pulsed, \leq 90- μ s pulse width, \leq 25% duty cycle	
Peak LED current, $I_{I(LED)(PK)}$: \leq 90- μ s pulse width, \leq 25% duty cycle	660 mA
\leq 2- μ s pulse width, \leq 10% duty cycle	1 A
Transmitter data input current range, I _{I(TXD)}	–12 mA to 12 mA
Storage temperature range, T _{stg}	–20°C to 85°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

	CONDITIONS	MIN	MAX	UNITS
Supply voltage, V _{CC}		4.75	5.25	V
Logic high transmitter input voltage, V_{IH}		4.25	5.25	V
Logic low transmitter input voltage, VIL		0.0	0.3	V
Logic high receiver input irrediance E	For in-band signals ≤ 116 kb/s	0.0036	500	mW/cm ²
Logic high receiver input irradiance, $E_{e(IH)}$	For in-band signals ≥ 576 kb/s	0.0090	500	mW/cm ²
Logic low receiver input irradiance, E _{e(IL)}	For in-band signals		0.3	μW/cm ²
LED (logic high) Current pulse amplitude, II(LEDA)		400	660	mA
Receiver setup time	For full sensitivity after transmitting		1.0	ms
Receiver signal rate, RXD-A		2.4	116	kb/s
Receiver signal rate, RXD-B		0.576	4	Mb/s
Ambient light	See IrDA serial infrared physical link specification, 1.1e Appendix A for Ambient levels and Appendix B			
Operating temperature, T _A	Case to ambient thermal resistance \leq 50°C/W	0	70	°C



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electrical characteristics at V_{CC} = 5 V, T_A = 25°C (unless otherwise noted); test conditions represent worst-case values for the parameters under test

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
VOL	Low-level output voltage, receiver data	RXD-A	$\begin{array}{l} I_{O} = 1 \text{ mA}, \\ \text{for in-band } E_{e} \geq 3.6 \ \mu\text{W/cm}^{2}, \\ \phi^{1/2} \leq 15^{\circ} \end{array}$			0.5	V
		RXD-B	$ \begin{array}{l} I_O = 1 \mbox{ mA}, \\ \mbox{for in-band } E_e \geq 9 \mu \mbox{W/cm}^2, \\ \varphi^{1/2} \leq 15^\circ \end{array} $			0.5	V
V _{OH} I	High-level output voltage, receiver data	RXD-A	I_O =– 20 $\mu A,$ for in-band E_e $\leq 0.3 \mu W/cm^2$	V _{CC} -0.6			V
		RXD-B	$I_O = -20 \ \mu\text{A},$ for in-band $E_e \le 0.3 \ \mu\text{W/cm}^2$	V _{CC} -1.2			V
۱ _{IL}	Low-level input current, transmitter data	lil(txd)	$GND \le V_{IL(TXD)} \le 0.3 V$	-2		2	μΑ
Чн	High-level input current, transmitter data	I _{IH(TXD)}	V _{IH(TXD)} = 4.25 V		40	250	μΑ
۷T	On-state voltage LED anode	VT(LEDA)	I _{I(LED)} = 400 mA at 25°C VIH(TXD) = 4.25 V			2.78	V
I _{D(lkg)}	OFF-state leakage current, LED anode	lD(lkg)(LEDA)	VI(LEDA) = V _{CC} = 5.25 V VIL(TXD) = 0.3 V			250	μA
ICC1	Supply current, idle state		$V_{CC} = 5.25 V$ $V_{I}(TXD) = V_{IL}, E_{e} = 0$		3	5.1	mA
ICC2	Supply current, active receiver		$V_{CC} = 5.25 V$ $V_{I(TXD)} = V_{IL},$ $E_{e} \le 500 \text{ nW/cm}^{2}$		4	18	mA

optical specifications

	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
2¢ ^{1/2}	Receiver viewing angle		±15			0
	Effective detector area			0.2		cm ²
le	Transmitter radiant intensity, logic high	$V_{IH(TXD)} = 4.25 V$ $I_{I(LED)} = 450 \text{ mA},$ $\Phi^{1/2} \le 15^{\circ}, T_A = 25^{\circ}C$	100	177		mW/sr
		$V_{IH(TXD)} = 4.25 V$ $I_{I(LED)} = 450 \text{ mA},$ $\Phi^{1/2} \le 15^{\circ}, 0^{\circ}\text{C} \le T_{\text{A}} \le 70^{\circ}\text{C}$	80	177		mW/sr
λp	Transmitter peak-emission wavelength			875		nm
$\Delta\lambda^{1/2}$	Transmitter spectral-line half-width			35		nm
$2\Phi^{1/2}$	Transmitter viewing angle		±15		±30	0
	Receiver peak-emission sensitivity wave length			880		nm



TSLM1100 Irda Compliant Transceiver

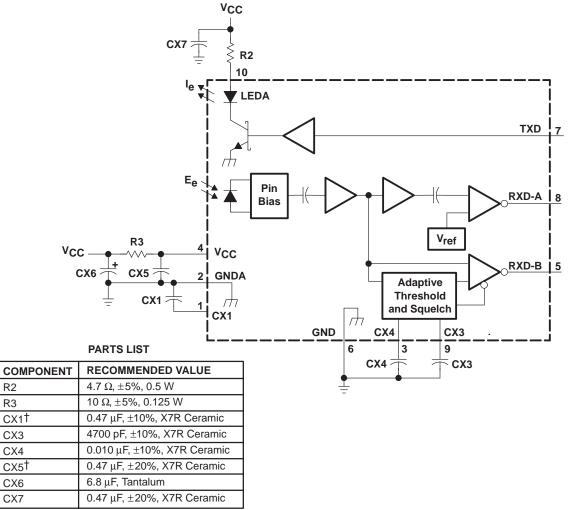
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switching characteristics

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
1 (5)40	Transmitter radiant intensity pulse width		I _e (PW)(TXD) = 1.6 μs at 115.2k pulses/s	1.5	1.6	1.8	μs
le(PW)			Ie(PW)(TXD) = 125 ns at 2M pulses/s	115	125	135	ns
	Transmitter redient intensity	Rise time	1 (2) (2) (2) (2) = 125 as at 2M pulses/s			40	
'e	Transmitter radiant intensity	Fall time	l _{e(PW)(TXD)} = 125 ns at 2M pulses/s				ns
	Pulse width	RXD-A	$\Phi^{1/2} = \le 15^{\circ}$	1		7.5	μs
PW	Pulse width	RXD-B	$\Phi^{\prime\prime\prime} = \leq 15^{\circ}$	75		185	ns
PW	Pulse width, RXD-B (ASK)		500 kHz, 50% duty cycle carrier ASK	0.7	1	1.3	μs
tL	Receiver latency time	RXD-A	-	0.5	0.5		
		RXD-B			ĺ	ms	

APPLICATION INFORMATION

schematic



⁺ CX1 and CX5 must be placed within 0.7 cm of the TSLM1100 to obtain optimum noise immunity.



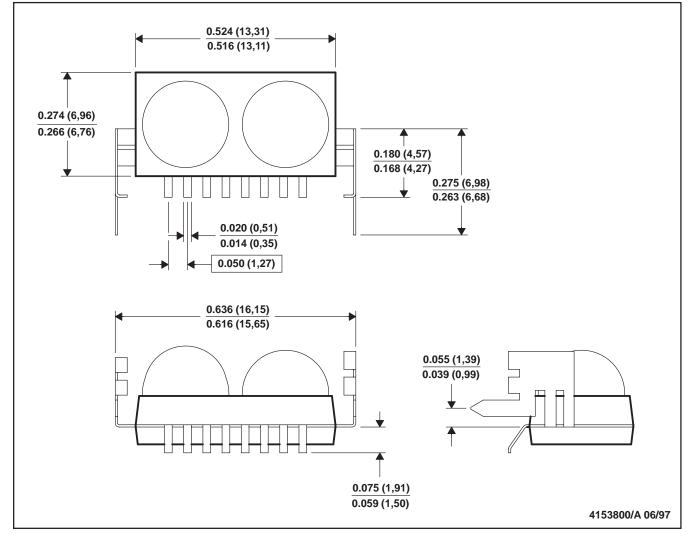
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MECHANICAL DATA

SRA (R-PSIP-T8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters). B. This drawing is subject to change without notice.



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